

**LINEAR TECHNOLOGY MATERIALS DECLARATION**

1t1360cs8#trpbf

(Engineering Calculation)

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**TOTAL MASS (g) : 0.072958**

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.001696	1000000	23246.2988281		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000071	1000000	973.164672852		
Lead Frame	A42	Copper (Cu)	7440-50-8	0.000000	0	0		
		Iron (Fe)	7439-89-6	0.014071	580000	192864.78125		
		Phosphorus (P)	7723-14-0	0.000000	0	0		
		Zinc (Zn)	7440-66-6	0.000000	0	0		
		Nickel (Ni)	7440-02-0	0.010189	420000	139655.984375		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
<b>Lead Frame Total:</b>				<b>0.024260</b>	<b>1000000</b>	<b>332520.75</b>		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.001477	1000000	20242.5371094		
		<b>External Plating Total:</b>				<b>0.001477</b>	<b>1000000</b>	<b>20242.5371094</b>
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000194	1000000	2659.06933594		
<b>Internal Plating Total:</b>				<b>0.000194</b>	<b>1000000</b>	<b>2659.06933594</b>		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.000623	750000	8539.17773438		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000208	250000	2850.96118164		
<b>Die Attach Total:</b>				<b>0.000831</b>	<b>1000000</b>	<b>11390.1376953</b>		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.006637	150000	90970.328125		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.036280	820000	497273.40625		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.001106	25000	15159.4384766		
		Carbon Black (C)	1333-86-4	0.000221	5000	3029.14624023		
		<b>Encapsulation Total:</b>				<b>0.044244</b>	<b>1000000</b>	<b>606432.3125</b>
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000185	1000000	2535.71069336		
					<b>TOTAL MASS (g) :</b>	<b>0.072958</b>		